# \$40,00 11782;

# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

# **CONVEYING PARTY DATA**

Name	Execution Date
Kan-Jung CHIA	05/04/2007
Shih-Ping HSU	05/10/2007

# **RECEIVING PARTY DATA**

Name:	Phoenix Precision Technology Corporation
Street Address:	No. 6, Li-Hsin Rd.
Internal Address:	Science-Based Industrial Park
City:	Hsinchu
State/Country:	TAIWAN
Postal Code:	R.O.C.

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11782356

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	4496-067
l .	II

NAME OF SUBMITTER: Kenneth M. Berner

Total Attachments: 1

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PATENT

500381008 REEL: 019996 FRAME: 0559

Docket No.: « 4496-067 »

# ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

1) Kan-Jung CHIA

Based Industrial Park, Hsinchu, Taiwan R. O. C.

Shih-Ping HSU

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

« Phoenix Precision Technology Corporation » having a place of business at No.6, Li-Hsin Rd., Science-

O \	, ,	, title and interest for the United States of America
as defined in 35 U.S.C. 100 in the inven	ition entitled	
Package Structure	e Having Semiconductor	Chip Embedded Therein

And Method For Fabricating The Same

- for which an application for United States Letters Patent was filed on United States Patent Application No.  $\frac{3uly}{1000}$ , and identified by the United States Patent Application No.  $\frac{11/782,356}{3000}$ ; or (a)
- (b) for which an application for United States Letters Patent was executed on \_\_\_\_\_\_,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

RECORDED: 10/22/2007

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PATENT REEL: 019996 FRAME: 0560